

WP3080APA

Enhancement Mode N-Channel Power MOSFET

PDFN5X6/NMOS/30V/±20V/1.7V/80A/3.8mΩ

Rev1.1





30V, $3.8m\Omega$, 80A, Single N-Channel

1.Features

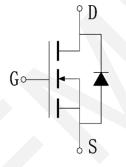
- ◆ 30V MOSFET technology
- Low on-state resistance
- Fast switching
- Vgs±20V

2.Applications

- Power Switching Application
- Load Switching



V _{DS}	R _{DS(on)} Typ.	I _D Max.	
30V	3.8mΩ @ 10V	004	
	6.8mΩ @ 4.5V	80A	



Schematic Diagram

3. Package Marking and Ordering Information

Part no.	Marking	Package	PCS/Reel	PCS/CTN.	
WP3080APA	WP3080APA	PDFN5X6	5,000	50,000	

4.Absolute Max Ratings at Ta=25°C (Note1)

Parameter	Symbol	Maximum	Units
Drain to Source Voltage	V _{DSS}	30	V
Gate to Source Voltage	V _{GSS}	±20	V
Drain Current (DC)	lo	80	А
Drain Current (Pulse), PW≤300µs	I _{DP}	280	А
Total Dissipation	PD	46	W
Avalanche Energy, Single Pulsed	E _{AS}	150	mJ
Junction Temperature	Tj	150	°C
Storage Temperature	T _{stg}	-55 to +150	°C

Note 1: Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



5.Thermal Resistance Ratings

Parameter	Symbol	Value	Unit
Junction to case	$R_{ extsf{ heta}JC}$	2.72	°C/W

Note 2: When mounted on 1 inch square copper board $t \le 10$ sec The value in any given application depends on the user's specific board design.

6.Electrical Characteristics at Ta=25°C (Note 3)

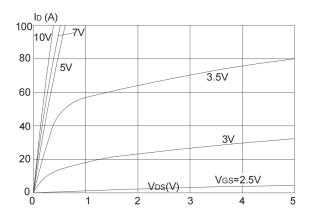
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Units
Drain to Source Breakdown Voltage	V _{(BR)DSS}	I _D = 250µA, V _{GS} = 0V	30			V
Zero-Gate Voltage Drain Current	I _{DSS}	V _{DS} = 30V, V _{GS} = 0V			1	μA
Gate to Source Leakage Current	I _{GSS1}	V_{GS} = ±20V, V_{SS} = 0V			±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _{DS} =250µA	1.0	1.7	2.5	V
Static Drain to Source On-State		I _D = 30A, V _{GS} = 10V - 3.8	3.8	5.5	mΩ	
Resistance	R _{DS(on)}	I _D = 20A, V _{GS} = 4.5V	-	6.8	8.9	mΩ
Input Capacitance	Ciss	V _{GS} =0V,		1615		pF
Output Capacitance	Coss	V _{DS} =15V,		245		pF
Reverse Transfer Capacitance	Crss	Frequency=1.0MHz		216		pF
Turn-ON Delay Time	t _{d(on)}			7.5		ns
Rise Time	tr	V_{DS} = 15V, I _D = 30A,		14.5		ns
Turn-OFF Delay Time	t _{d(off)}	$V_{GS} = 10V,$ $R_G = 3\Omega$		35		ns
Fall Time	t _f			9.6		ns
	Qg	V _{DS} = 15V,		33.8		nC
Total Gate Charge	Q _{gs}	$V_{GS} = 10V,$		8.5		nC
	Q _{gd}	I _D = 30A		7.5		nC
Diode Forward Voltage	V _{FSD}	$I_{\rm S}$ = 30A, $V_{\rm GS}$ = 0		0.9	1.2	V

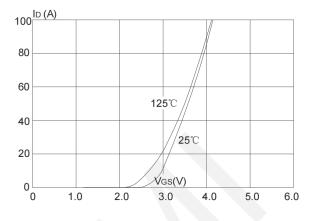
Note 3 : Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.



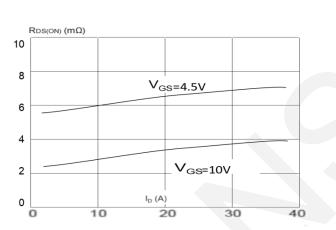


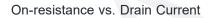
7. Typical electrical and thermal characteristics

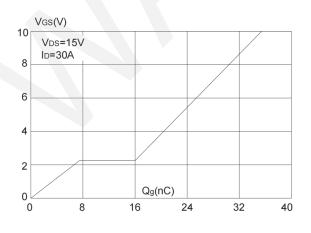




Output Characteristics

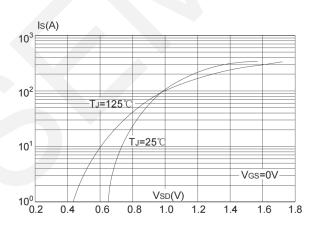




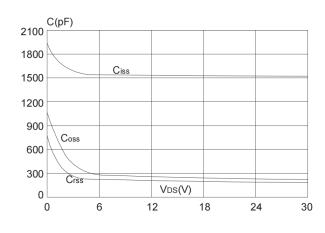


Gate Charge Characteristics

Typical Transfer Characteristics



Body Diode Characteristics

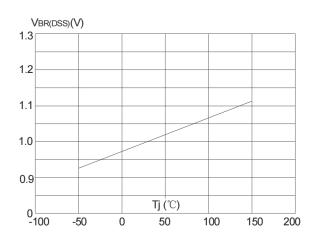


Capacitance Characteristics

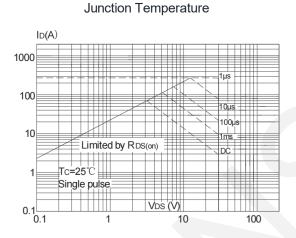
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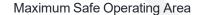
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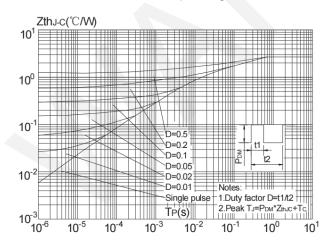




Normalized Breakdown Voltage vs.

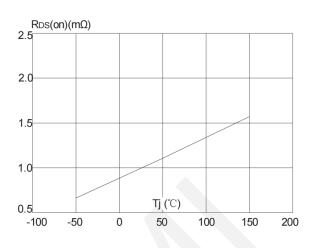




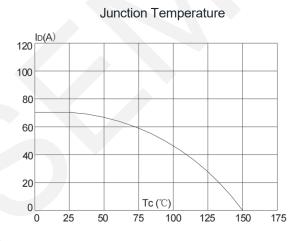


Maximum Effective Transient

Thermal Impedance, Junction-to-Case



Normalized on Resistance vs.



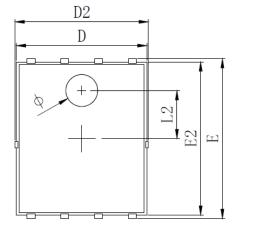
Maximum Continuous Drain Current vs.

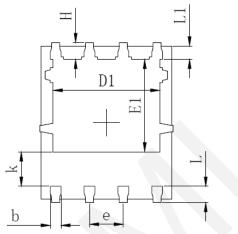
Case Temperature

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8.Package Dimensions





MILLIMETER			
SYMBOL		MILLIMETER	
	MIN	Typ.	MAX
А	0.900	1.000	1.100
A1		0.254 REF.	
A2		0 [~] 0.05	
D	4.824	4.900	4.976
D1	3. 910	4.010	4.110
D2	4.924	5.000	5.076
E	5. 9 24	6.000	6.076
E1	3. 375	3. 475	3.575
E2	5.674	5.750	5.826
b	0.350	0.400	0.450
е	1.270 TYP.		
L	0.534	0.610	0.686
L1	0.424	0.500	0.576
L2	1.800 REF.		
k	1.190	1.290	1.390
Н	0.549	0.625	0.701
θ	8°	10°	12°
Φ	1.100	1.200	1.300
d			0.100



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